



60V 175°C PNP LOW SAT MEDIUM POWER TRANSISTOR IN POWERDI5060-8

Features

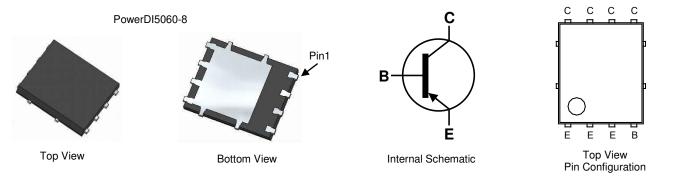
- BV_{CEO} > -60V
- I_C = -3A Continuous Collector Current
- I_{CM} = -8A Peak Pulse Current
- R_{CE(SAT)} < 120 mΩ
- Rated to +175°C—Ideal for High Ambient Temperature Environments
- Complementary Part DXTN3C60PS
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: PowerDI®5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish—Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)

Applications

- Power Management
- Load Switch
- Linear Mode Voltage Regulator
- Backlighting Applications



Ordering Information (Note 4)

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Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
DXTP3C60PS-13	AEC-Q101	DXTP3C60PS	13	12	1000

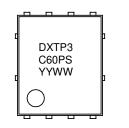
Notes: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, see http://www.diodes.com/products/packages.html.

Marking Information



DXTP3 = Product Type Marking Code C60PS = Product Type Marking Code YYWW = Date Code Marking YY = Last Digit of Year (ex: 18 = 2018) WW = Week Code (01 to 53)

PowerDI is a registered trademark of Diodes Incorporated



Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-60	V
Collector-Emitter Voltage	V _{CEO}	-60	V
Emitter-Base Voltage	V _{EBO}	-7	V
Base Current	IB	-1	A
Continuous Collector Current	lc	-3	А
Peak Pulse Collector Current	I _{CM}	-8	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Power Dissipation	(Note 6)	PD	5	W	
Thermal Resistance, Junction to Lead	(Note 5)	R _{ØJL}	5.6	°C/W	
Thermal Desistance, Junction to Ambient	(Note 5)	P	73	°C/W	
Thermal Resistance, Junction to Ambient	(Note 6)	R _{ÐJA}	30		
Operating and Storage Temperature Range		TJ, T _{STG}	-55 to +175	°C	

ESD Ratings (Note 7)

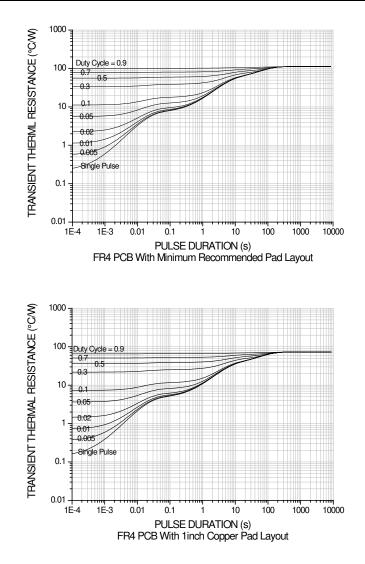
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	8000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

5. For a device mounted with the collector lead on 25mm × 25mm 1oz copper that is on single-sided 1.6mm FR4 PCB; device is measured under still air Notes: conditions whilst operating in a steady-state.

6. Same as Note 5, except the device is measured at t \leq 5 sec. 7. Refer to JEDEC specification JESD22-A114 and JESD22-A115.



Thermal Characteristics and Derating Information





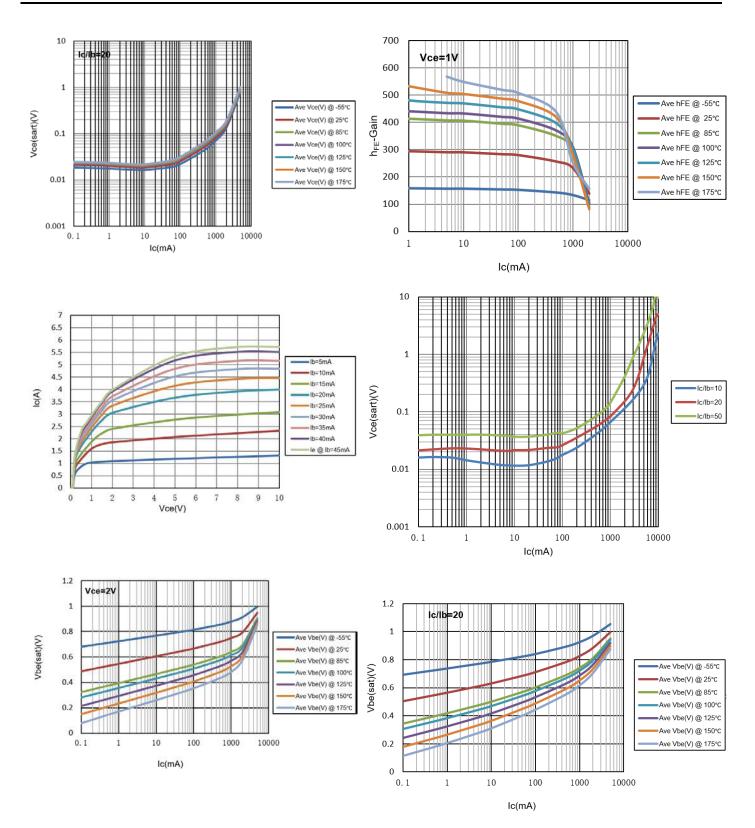
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Мах	Unit	Test Condition
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	BV _{CBO}	-60	—	—	V	$I_{C} = -100\mu A$
Collector-Emitter Breakdown Voltage (Note 8)	BV _{CEO}	-60	—	_	V	I _C = -10mA
Emitter-Base Breakdown Voltage	BV _{EBO}	-7	—	_	V	I _E = -100μA
Collector-Base Cutoff Current		_	—	-100	nA	V _{CB} = -48V
Collector-Base Cuton Current	ICBO	_	—	-50	μA	V _{CB} = -48V @ Tj = 150°C
Emitter Cutoff Current	I _{EBO}	_	—	100	nA	V _{EB} = -7V
Collector-Emitter Cutoff Current	I _{CES}	_	—	100	nA	V _{CES} = -48V
ON CHARACTERISTICS (Note 9)						
		150	250	—		$I_{C} = -500 mA, V_{CE} = -2V$
DC Current Gain	6	150	225	—		$I_C = -1A$, $V_{CE} = -2V$
	h _{FE}	80	130	_	_	$I_C = -2A, V_{CE} = -2V$
		35	75	—		$I_{C} = -3A, V_{CE} = -2V$
		_	-100	-225	mV	I _C = -1A, I _B = -50mA
Collector-Emitter Saturation Voltage	V _{CE(sat)}	_	-240	-360		I _C = -3A, I _B = -300mA
Collector-Emitter Saturation Resistance	5	_	100	225	mΩ	I _C = -1A, I _B = -50mA
Collector-Emiller Saturation Resistance	R _{CE(sat)}	_	80	120		I _C = -3A, I _B = -300mA
Page Emitter Seturation Voltage	N	_	-0.8	-0.95	V	I _C = -1A, I _B = -50mA
Base-Emitter Saturation Voltage	V _{BE(sat)}	_	-1.02	-1.2		I _C = -2A, I _B = -200mA
Base-Emitter Turn-On Voltage	V _{BE(on)}		-0.7	-0.8	V	I _C = -0.5A, V _{CE} = -2V
SMALL SIGNAL CHARACTERISTICS						
Current Gain-Bandwidth Product	f⊤	_		—	MHz	$V_{CE} = -10V, I_C = -500mA, f = 100MHz$
Output Capacitance	Cobo	_	42	_	pF	V _{CB} = -10V, f = -1MHz
Delay Time	td	_	15	_	ns	
Rise Time	tr		220	_	ns	
Turn-On Time	t _(on)	_	235	_	ns	V _{CC} = -12.5V, I _C = 3A
Storage Time	ts	_	160	_	ns	I _{B1} = -I _{B2} = -0.150A
Fall Time	t _f	_	185		ns	
Turn-Off Time	t _(off)	_	345		ns	1

Note: 8. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.



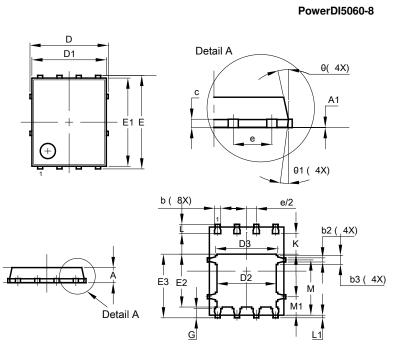
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)





Package Outline Dimensions

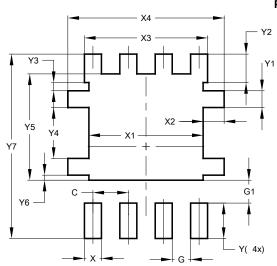
Please see http://www.diodes.com/package-outlines.html for the latest version.



	PowerDI5060-8				
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0.00	0.05	-		
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D		5.15 BSC			
D1	4.70	5.10	4.90		
D2	3.70	4.10	3.90		
D3	3.90 4.30 4.1		4.10		
Е	6.15 BSC				
E1	5.60	6.00	5.80		
E2	3.28	3.68	3.48		
E3	3.99	4.39	4.19		
е	1.27 BSC				
G	0.51	0.71	0.61		
K	0.51	_	—		
L	0.51	0.71	0.61		
L1	0.100 0.200 0.1		0.175		
М			3.635		
M1	1.00	1.40	1.21		
Θ	10°	12°	11°		
Θ1	6°	8°	7°		
Al	All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



PowerDI5060-8

Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	0.755
X3	4.420
X4	5.610
Y	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610



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